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Team Nexperia



ESD protection for high-speed interfaces Rev. 2 — 13 December 2012

Product data sheet

Product profile 1.

1.1 General description

The device is designed to protect high-speed interfaces such as USB 2.0, Ethernet and Digital Visual Interface (DVI) against ElectroStatic Discharge (ESD).

The device includes four high-level ESD protection diode structures for high-speed signal lines and is encapsulated in a leadless ultra small DFN1410-6 (SOT886) plastic package.

Special diode configuration protects all signal lines and offers ultra low line capacitance of only 1 pF. The rail-to-rail diodes are connected to the Zener diode which allows ESD protection to be independent of supply voltage.

1.2 Features and benefits

- System ESD protection for high-speed data lines such as USB 2.0, Ethernet and DVI
- All signal lines with integrated rail-to-rail clamping diodes for downstream ESD protection of ±8 kV according to IEC 61000-4-2, level 4
- Line capacitance of only 1 pF for each channel
- Leadless ultra small DFN1410-6 package: 1 × 1.45 × 0.5 mm; pitch 0.5 mm

1.3 Applications

The device is designed for high-speed receiver and transmitter port protection:

- Mobile phones, smartphones and handsets
- TVs and monitors
- DVD recorders and players
- Notebooks, mother boards, graphic cards and ports
- Set-top boxes and game consoles



001aag273

ESD protection for high-speed interfaces

2. Pinning information

Table	e 1. Pinning	9		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	I/O 1	ESD protection		
2	GND	ground		6 5 4
3	I/O 2	ESD protection		
4	I/O 3	ESD protection		
5	V _{CC}	supply voltage		
6	I/O 4	ESD protection	Transparent top view	

3. Ordering information

Table 2. Orde	ring informatior	1				
Type number	Package	Package				
	Name	Description	Version			
IP4221CZ6-S	DFN1410-6	plastic extremely thin small outline package; no leads; 6 terminals; body 1 \times 1.45 \times 0.5 mm	SOT886			

4. Marking

Table 3. Marking codes	
Type number	Marking code
IP4221CZ6-S	1S

5. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
VI	input voltage		-0.5	+5.5	V
V _{ESD}	electrostatic discharge voltage	IEC 61000-4-2, level 4; contact discharge	<u>[1]</u> –8	+8	kV
T _{stg}	storage temperature		-55	+125	°C
T _{amb}	ambient temperature		-40	+85	°C

[1] All pins to ground.

ESD protection for high-speed interfaces

6. Characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
C _(I/O-GND)	input/output to ground capacitance	V _I = 0 V; f = 1 MHz; V _{CC} = 3 V	<u>[1][2]</u>	-	1	1.2	pF
I _{RM}	reverse leakage current	V _I = 3 V	[3][2]	-	-	100	nA
V _{BRzd}	Zener diode breakdown voltage	l _l = 1 mA	<u>[4]</u>	6	-	9	V
V _F	forward voltage	I _{test} = 10 mA		-	0.7	-	V

[2] Pins 1, 3, 4 and 6 are measured to ground.

[3] All pins measured to ground (pin 2).

[4] Measured from pin 5 to pin 2.

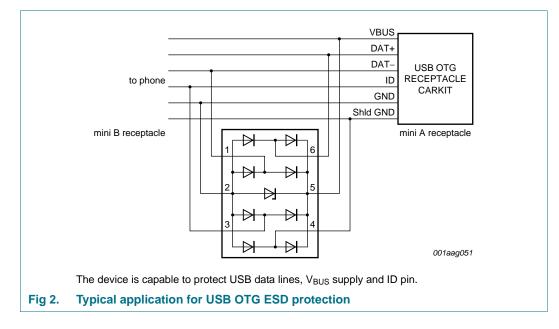
7. Application information

VBUS DAT+ DAT-USB DAT-DAT-PORT GND ⊳ ₽ ⊳ ₽ USB 2.0/ **IEEE 1394** CONTROLLER ₽ VBUS DAT+ DAT+ USB DAT-DAT-PORT GND 001aah371 Each device is capable to protect USB data lines and V_{BUS} supply. Fig 1. Typical application for USB ESD protection

7.1 USB 1.1 and 2.0 protection

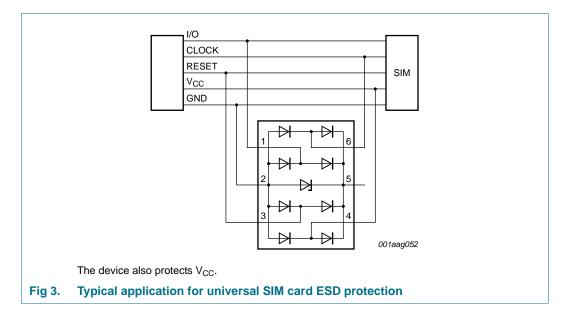
IP4221CZ6-S

ESD protection for high-speed interfaces

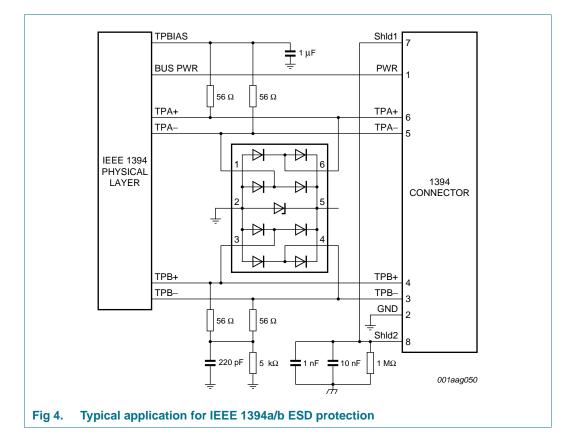


7.2 USB On-The-GO (OTG) protection

7.3 Universal SIM card protection

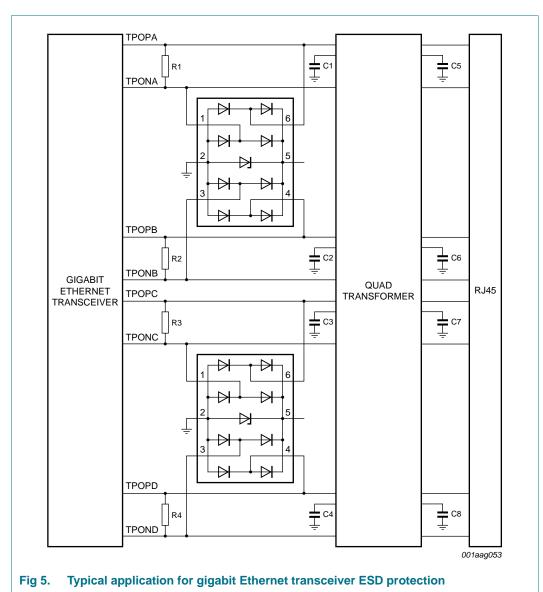


ESD protection for high-speed interfaces



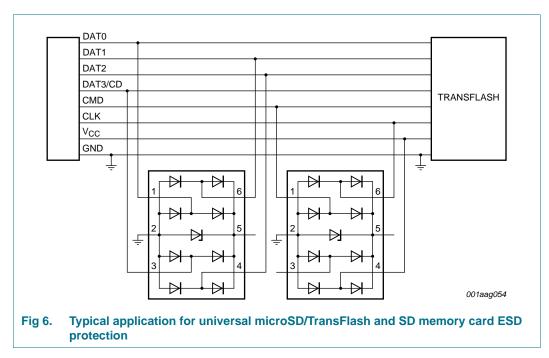
7.4 IEEE 1394a/b protection

ESD protection for high-speed interfaces



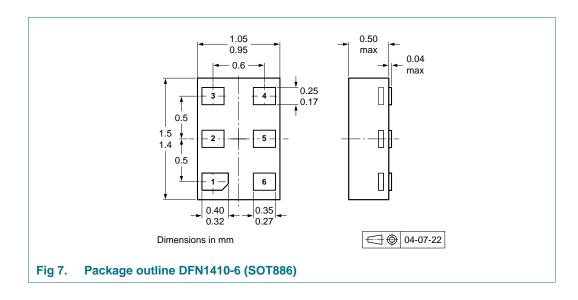
7.5 Gigabit Ethernet transceiver protection

ESD protection for high-speed interfaces



7.6 Universal microSD/TransFlash and SD memory card protection

8. Package outline



ESD protection for high-speed interfaces

9. Packing information

Table 6. Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code. [1]

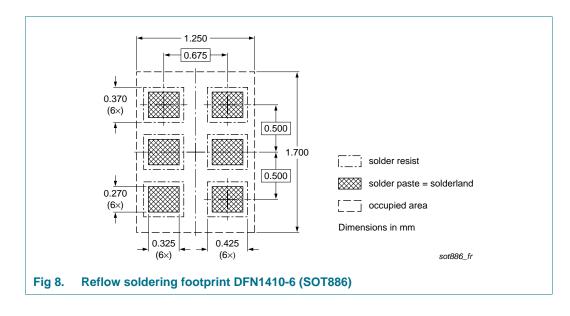
Type number	Package	Description		Packing quantity
				5000
IP4221CZ6-S		4 mm pitch, 8 mm tape and reel; T1	[2]	-115
	(SOT886)	4 mm pitch, 8 mm tape and reel; T4	[3]	-132

[1] For further information and the availability of packing methods, see <u>Section 13</u>.

[2] T1: normal taping

[3] T4: reverse taping

10. Soldering



P4221CZ6-S Product data sheet

ESD protection for high-speed interfaces

11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes			
IP4221CZ6-S v.2	20121213	Product data sheet	-	IP4221CZ6-S v.1			
Modifications:	Section 1 "I	 Section 1 "Product profile": updated 					
	 Section 4 "I 	Marking": added					
	 Section 5 "I 	<u>imiting values"</u> : T _{amb} added					
	 Recommended operating conditions: removed Table 5 "Characteristics": updated 						
	 Section 7 "Application information": updated 						
	• Section 8 "Package outline": drawing replaced with minimized package outline drawing						
	 Section 10 "Soldering": updated 						
	Section 12	"Legal information": updated					
IP4221CZ6-S v.1	20080429	Product data sheet	-	-			

ESD protection for high-speed interfaces

12. Legal information

12.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

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P4221CZ6-S Product data sheet

ESD protection for high-speed interfaces

14. Contents

1	Product profile 1
1.1	General description 1
1.2	Features and benefits 1
1.3	Applications 1
2	Pinning information 2
3	Ordering information 2
4	Marking 2
5	Limiting values 2
6	Characteristics 3
7	Application information 3
7.1	USB 1.1 and 2.0 protection
7.2	USB On-The-GO (OTG) protection 4
7.3	Universal SIM card protection
7.4	IEEE 1394a/b protection 5
7.5	Gigabit Ethernet transceiver protection 6
7.6	Universal microSD/TransFlash and SD memory
	card protection 7
8	Package outline 7
9	Packing information 8
10	Soldering 8
11	Revision history
12	Legal information 10
12.1	Data sheet status 10
12.2	Definitions
12.3	Disclaimers 10
12.4	Trademarks 11
13	Contact information 11
14	Contents 12

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